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**MOTOROLA**

# M68040 User's Manual

Including the  
MC68040,  
MC68040V,  
MC68LC040,  
MC68EC040,  
and  
MC68EC040V



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## PREFACE

The complete documentation package for the MC68040, MC68040V, MC68LC040, MC68EC040, and MC68EC040V (collectively called M68040) consists of the M68040UM/AD, *M68040 User's Manual*, and the M68000PM/AD, *M68000 Family Programmer's Reference Manual*. The *M68040 User's Manual* describes the capabilities, operation, and programming of the M68040 32-bit third-generation microprocessors. The *M68000 Family Programmer's Reference Manual* contains the complete instruction set for the M68000 family.

The introduction of this manual includes general information concerning the MC68040 and summarizes the differences between the M68040 member devices. Additionally, three appendices provide detailed information on how these M68040 derivatives operate differently from the MC68040. For detailed information on one of these M68040 derivatives, use the following table to determine which appendices to read in conjunction with the rest of this manual.

Device Number	Appendices
MC68040V	<b>Appendix A MC68LC040</b> and <b>Appendix C MC68040V and MC68EC040V</b>
MC68LC040	<b>Appendix A MC68LC040</b>
MC68EC040	<b>Appendix B MC68EC040</b>
MC68EC040V	<b>Appendix B MC68EC040</b> and <b>Appendix C MC68040V and MC68EC040V</b>

When reading this manual, **remember** to disregard information concerning floating-point in reference to the MC68040V and MC68LC040, and to disregard information concerning floating-point and memory management in reference to the MC68EC040 and MC68EC040V. The organization of this manual is as follows:

Section 1	Introduction
Section 2	Integer Unit
Section 3	Memory Management Unit (Except MC68EC040 and MC68EC040V)
Section 4	Instruction and Data Caches
Section 5	Signal Description
Section 6	IEEE 1149.1 Test Access Port (JTAG)
Section 7	Bus Operation
Section 8	Exception Processing
Section 9	Floating-Point Unit (MC68040)
Section 10	Instruction Timings
Section 11	MC68040 Electrical and Thermal Characteristics
Section 12	Ordering Information and Mechanical Data
Appendix A	MC68LC040
Appendix B	MC68EC040
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Appendix D	M68000 Family Summary
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**Appendix D  
M68000 Family Summary**

**Appendix E  
Floating-Point Emulation (M68040FPSP)**

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## SECTION 1 INTRODUCTION

The MC68040, MC68040V, MC68LC040, MC68EC040, and MC68EC040V (collectively called M68040) are Motorola's third generation of M68000-compatible, high-performance, 32-bit microprocessors. All five devices are virtual memory microprocessors employing multiple concurrent execution units and a highly integrated architecture that provides very high performance in a monolithic HCMOS device. They integrate an MC68030-compatible integer unit (IU) and two independent caches. The MC68040, MC68040V, and MC68LC040 contain dual, independent, demand-paged memory management units (MMUs) for instruction and data stream accesses and independent, 4-Kbyte instruction and data caches. The MC68040 contains an MC68881/MC68882-compatible floating-point unit (FPU). The use of multiple independent execution pipelines, multiple internal buses, and a full internal Harvard architecture, including separate physical caches for both instruction and data accesses, achieves a high degree of instruction execution parallelism on all three processors. The on-chip bus snoop logic, which directly supports cache coherency in multimaster applications, enhances cache functionality.

The M68040 family is user object-code compatible with previous M68000 family members and is specifically optimized to reduce the execution time of compiler-generated code. All five processors implement Motorola's latest HCMOS technology, providing an ideal balance between speed, power, and physical device size.

### 1.1 DIFFERENCES

Because the functionality of individual M68040 family members are similar, this manual is organized so that the reader will take the following differences into account while reading the rest of this manual. Unless otherwise noted, all references to M68040, with the exception of the differences outlined below, will apply to the MC68040, MC68040V, MC68LC040, MC68EC040, and MC68EC040V. The following paragraphs describe the differences of MC68040V, MC68LC040, MC68EC040, and the MC68EC040V from the MC68040.

#### 1.1.1 MC68040V and MC68LC040

The MC68040V and MC68LC040 are derivatives of the MC68040. They implement the same IU and MMU as the MC68040, but have no FPU. The MC68LC040 is pin compatible with the MC68040. The MC68040V is not pin compatible with the MC68040 and contains some additional features. The following differences exist between the MC68040V, MC68LC040, and MC68040:

- The DLE pin name has been changed to JS0 on both the MC68040V and MC68LC040. In addition, the MC68040V contains three new pins, system clock disable (SCD), low frequency operation (LFO), and loss of clock (LOC).
- The MC68040V and MC68LC040 do not implement the data latch enable (DLE), multiplexed, or output buffer impedance selection modes of operation. They implement only the small output buffer mode of operation. All timing and drive capabilities on both devices are equivalent to those of the MC68040 in small output buffer impedance mode. The MC68040V has an additional mode of operation, the low-power stop mode of operation.
- The MC68040V and MC68LC040 do not contain an FPU, causing unimplemented floating-point exceptions to occur using a new stack frame format.
- The MC68040V is a 3.3 volt static microprocessor that operates down to 0 MHz.

For specific details on the MC68LC040, refer to **Appendix A MC68LC040**. For specific details on the MC68040V, refer to both **Appendix A MC68LC040** and **Appendix C MC68040V and MC68EC040V**. **Disregard all information concerning the FPU** when reading the following subsections.

### 1.1.2 MC68EC040 and MC68EC040V

The MC68EC040 and MC68EC040V are derivatives of the MC68040. They implement the same IU as the MC68040, but have no FPU or MMU, which embedded control applications generally do not require. The MC68EC040 is pin compatible with the MC68040. The following differences exist between the MC68EC040, MC68EC040V, and the MC68040:

- The DLE and MDIS pin names have been changed to JS0 and JS1, respectively.
- PTEST and PFLUSH instructions cause an undetermined number of bus cycles; the user should not execute these instructions.
- The access control unit (ACU) replaces the MMU. The MC68EC040 and MC68EC040V ACU has two data and two instruction registers that are called data and instruction transparent translation registers in the MC68040.
- The MC68EC040 and MC68EC040V do not implement the DLE, multiplexed, or output buffer impedance selection modes of operation. They only implement the small output buffer mode of operation. All MC68EC040 and MC68EC040V timing and drive capabilities are equivalent to the MC68040 in small output buffer mode.
- The MC68EC040 and MC68EC040V do not contain an FPU, causing unimplemented floating-point exceptions to occur using a new stack frame format.
- The MC68040V is a 3.3 volt static microprocessor that operates down to 0 MHz.

Refer to **Appendix B MC68EC040** for specific details on the MC68EC040. Refer to **Appendix B MC68EC040** and **Appendix C MC68040V and MC68EC040V** for specific details on the MC68EC040V. **Disregard information concerning the FPU and MMU** when reading the following subsections.



## 1.2 FEATURES

The main features of the M68040 are as follows:

- 6-Stage Pipeline, MC68030-Compatible IU
- MC68881/MC68882-Compatible FPU
- Independent Instruction and Data MMUs
- Simultaneously Accessible, 4-Kbyte Physical Instruction Cache and 4-Kbyte Physical Data Cache
- Low-Latency Bus Accesses for Reduced Cache Miss Penalty
- Multimaster/Multiprocessor Support via Bus Snooping
- Concurrent IU, FPU, MMU, and Bus Controller Operation Maximizes Throughput
- 32-Bit, Nonmultiplexed External Address and Data Buses with Synchronous Interface
- User Object-Code Compatible with All Earlier M68000 Microprocessors
- 4-Gbyte Direct Addressing Range
- Software Support Including Optimizing C Compiler and UNIX® System V Port

The on-chip FPU and large physical instruction and data caches yield improved system performance and increased functionality. The independent instruction and data MMUs and increased internal parallelism also improve performance.

## 1.3 EXTENSIONS TO THE M68000 FAMILY

The M68040 is compatible with the ANSI/IEEE *Standard 754 for Binary Floating-Point Arithmetic*. The MC68040's FPU has been optimized to execute the most commonly used subset of the MC68881/MC68882 instruction sets and includes additional instruction formats for single- and double-precision rounding results. Software emulates floating-point instructions not directly supported in hardware. Refer to **Appendix E M68040 Floating-Point Emulation (MC68040FPSP)** for details on software emulation. The MOVE16 user instruction is new to the instruction set, supporting efficient 16-byte memory-to-memory data transfers.

## 1.4 FUNCTIONAL BLOCKS

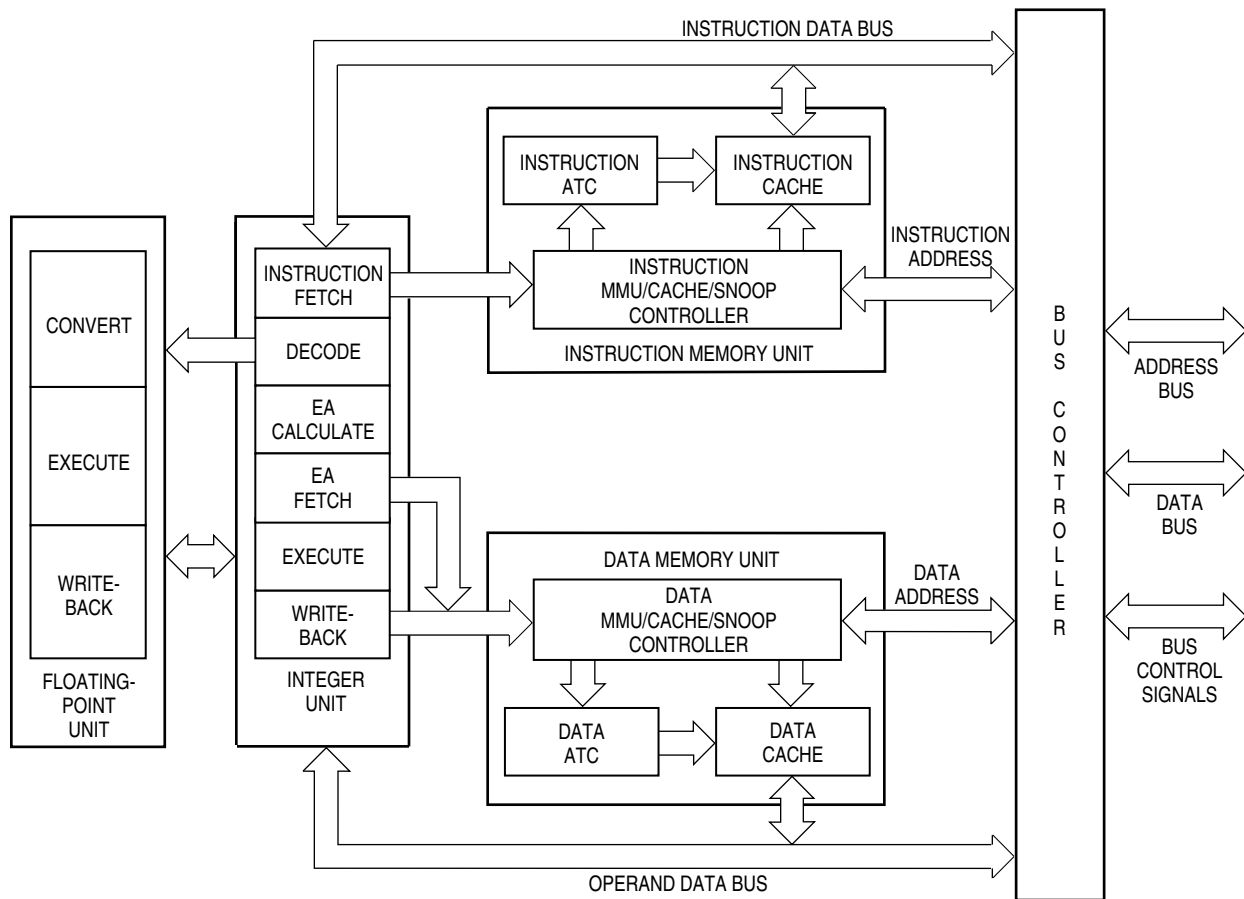
Figure 1-1 illustrates a simplified block diagram of the MC68040. Refer to **Appendix A MC68LC040** for information on the MC68LC040's and MC68040V's functional blocks; and **Appendix B MC68EC040** for information on the MC68EC040's and MC68EC040V's functional blocks.

The M68040 IU pipeline has been expanded from the MC68030 to include effective address calculation (<ea> calculate) and operand fetch (<ea> fetch) stages with commonly used effective addressing modes. Conditional branches are optimized for the

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more common case of the branch taken, and both execution paths of the branch are fetched and decoded to minimize refilling of the instruction pipeline.



**Figure 1-1. Block Diagram**

To improve memory management, the M68040 includes separate, independent paged MMUs for instruction and data accesses. Each MMU stores recently used address mappings in separate 64-entry address translation caches (ATCs). Each MMU also has two transparent translation registers that define a one-to-one mapping for address space segments ranging in size from 16 Mbytes to 4 Gbytes each.

Two memory units independently interface with the IU and FPU. Each unit consists of an MMU, an ATC, a main cache, and a snoop controller. The MMUs perform memory management on a demand-page basis. By translating logical-to-physical addresses using translation tables stored in memory, the MMUs support virtual memory systems. Each MMU stores recently used address mappings in an ATC, reducing the average translation time.

Separate on-chip instruction and data caches operate independently and are accessed in parallel with address translation. The caches improve the overall performance of the system by reducing the number of bus transfers required by the processor to fetch information from memory and by increasing the bus bandwidth available for alternate bus